	connectors	S							
S	PECIFICATION								
宏致電	了子股份有限	2公司							
桃	園縣中壢市東園路13號								
No.	13, Dongyuan Rd., Jhongli City	Ϋ,							
Таоу	uan County 320, Taiwan (R.O.	C.)							
	2: +886-3-463-2808 X: +886-3-463-1800								
SPEC. NO.: PS-52533-XX	REV	ISION: <u>A</u>							
PRODUCT NAME: 0.8m	m PITCH EASY ON FPC C	CONN.							
PRODUCT NO: 52533 SERIES									
PREPARED:	CHECKED:	APPROVED:							
SUN, YA JIE	SUN, YA JIE XU, ZHI YONG XU, ZHI YONG								
DATE: 2022/05/13	DATE: 2022/05/13	DATE: 2022/05/13							

2010/10/31 TR-FM-73015L

CES	Aces P/N	⊮ 52533 series	
TITLE: 0.8MM PITCH EAS	Y ON FPC CONN. SMT F	R/A B/C TYPE	
RELEASE DATE: 2022.05.13	REVISION: A	ECN No: ECN-008045	PAGE: 2 OF 10
 2 SCOPE 3 APPLICABLE 4 REQUIREMEN 5 PERFORMAN 6 INFRARED RE 7 PRODUCT QU 	DOCUMENTS NTS CE EFLOW CONDITIC	DN D TEST SEQUENCE	

ACES

Aces P/N: 52533 series

TITLE: 0.8MM PITCH EASY ON FPC CONN. SMT R/A B/C TYPE

RELEASE DATE: 2022.05.13 REVISION: A

ECN No: ECN-008045

PAGE: 3 OF 10

1 Revision History

Rev.	ECN #	Revision Description	Prepared	Date
Α	ECN-008045	FOR APD1090336	SUNYAJIE	2022.05.13

				Aces P/N: 5	2533 series	
Т	ITLE: 0.8MM	I PITCH EAS	Y ON FPC CON	IN. SMT R/A E	B/C TYPE	
REL	EASE DATE: 202	2.05.13	REVISION: A		ECN No: ECN-008045	PAGE: 4 OF 10
2			vers performa		nd quality requirements	s for 0.8 mm pitch
3		BLE DOC	UMENTS	TRIES ASS	OCIATION	
4	REQUIRE	EMENTS				
	4.1 Design	and Construe	ction			
	4.1.1	Product sha		construction a	nd physical dimensions spe	cified on applicable
	4.1.2	•	•	R.o.H.S. and	the standard depends on	TQ-WI-140101.
	4.2 Materia	ls and Finish				
		Plated: ((Housing: Th	h performance a) Finish: Gold b) Under plate permoplastic, H permoplastic, H	d flash overal Nickel-plate ligh temp. Ul	ed overall _94V-0	
	4.3 Ratings					
	4.3.2 4.3.3	Voltage: 50 Current: DC	age less than V AC 0.5 Amperes emperature : -4	Per Pin		
				Page 4		/10/31 TR-FM-73015L

CES	Aces	P/N: 52533 series	
TITLE: 0.8MM PITCH EAS	Y ON FPC CONN. SM	T R/A B/C TYPE	
RELEASE DATE: 2022.05.13	REVISION: A	ECN No: ECN-008045	PAGE: 5 OF 10

5 Performance

5.1. Test Requirements and Procedures Summary

ltem	Requirement	Standard
	Product shall meet requirements	Visual, dimensional and functional per
Examination of Product	of applicable product drawing	applicable quality inspection plan.
	and specification.	
	ELECTRICA	NL
		Mate connectors, measure by dry circuit, 20mV Max., 100mA Max.
Low Level Contact Resistance	Initial:50 mΩ Max. Final:100 mΩ Max.	(EIA-364-23)
		Unmated connectors, apply
Insulation Resistance	Initial: 100 M Ω Min.	500 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No discharge, flashover or breakdown. Current leakage: 2 mA max.	500 VAC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature rise	30°C Max. Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at $25^{\circ}C$ (EIA-364-70,METHOD1,CONDITION1)
	MECHANIC	
		The sample should be mounted in the
Durability	30 cycles.	tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3 mm/min. (EIA-364-09)
Terminal / Housing Retention Force	0.2kgf MIN.	Operation Speed : 25.4 \pm 3 mm/minute. Measure the contact retention force with Tensile strength tester.
Fitting nail / Housing Retention Force	0.3kgf MIN.	Operation Speed : 25.4 ± 3 mm/minute. Measure the contact retention force with

Aces P/N: 52533 series									
TITLE: 0.8MM PITCH EAS	ON FPC CONN. SMT R/A	B/C TYPE							
RELEASE DATE: 2022.05.13	RELEASE DATE: 2022.05.13 REVISION: A ECN No: ECN-008045 PAGE: 6 OF 10								
		Tensile strength tester.							
FPC Retention Force	0.5kgf MIN. Carbon: 0.015kgf/PIN MIN	A connector shall be soldered on a board and insert the actuator, pull the FPC at the speed rate of 25.4 ± 3 mm/min.							
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)							
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50 G's (peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be DC 100mA maximum for all contacts. (EIA-364-27, test condition A)							

Aces P/N: 52533 series

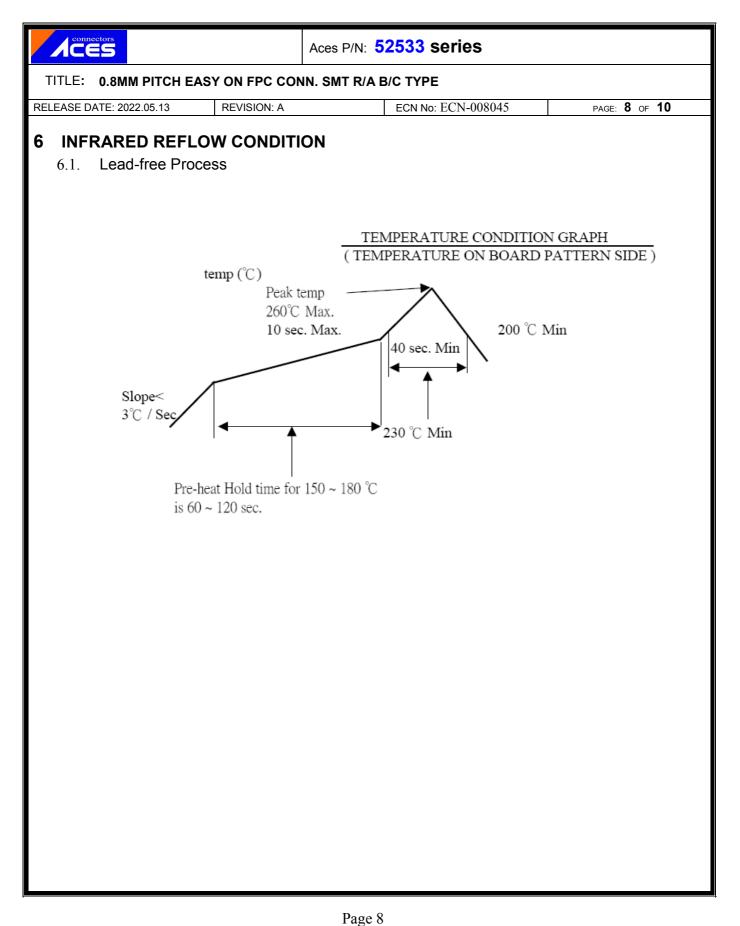
TITLE: 0.8MM PITCH EASY ON FPC CONN. SMT R/A B/C TYPE

RELEASE DATE: 2022.05.13 REVISION: A

ECN No: ECN-008045

PAGE: 7 OF 10

ENVIRONMENTAL							
Item	Requirement	Standard					
Hand Soldering Temperature Resistance	Appearance: No damage	T≧350°C, 3sec at least.					
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 10 (Lead Free)	Pre Heat : 150℃~180℃, 60~120sed Heat : 230℃ Min., 40sec Min. Peak Temp. : 260℃ Max, 10sec Max.					
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55 +0/-3 °C, 30 minutes +85 +3/-0 °C, 30 minutes (EIA-364-32, test condition I)					
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40°C, 90~95% RH, 96 hours. (EIA-364-31,Condition A, Method II)					
Temperature life	See Product Qualification and Test Sequence Group 5	Subject mated connectors to temperature life at 85°C for 96 hours. (EIA-364-17, Test condition A)					
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35°C (I) Gold flash for 8 hours (II) Gold plating 5 u" for 96 hours. (EIA-364-26)					
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage.	And then into solder bath, Temperature at 245 ±5°C, for 4-5 sec. (EIA-364-52)					



CES	Ac	ces P/N	J: 52	533	seri	es					
ITLE: 0.8MM PITCH EASY ON FPC CO	ONN.	SMT R	R/A B/0	С ТҮР	E						
EASE DATE: 2022.05.13 REVISION: A				ECN No	o: ECN	-00804	5		PA	ge: 9	DF 10
PRODUCT QUALIFICATION	AND	TES	T SE	QUE		=					
		Test Group									
Test or Examination	1	2	3	4	5	6	7	8	9	10	11
			I	I	Tes	t Seque	ence	I	I	1	
Examination of Product				1、7	1、6	1、4			1	1	
Low Level Contact Resistance		1、5	1、4	2、10	2、9	2 \ 5			3		
Insulation Resistance				3 • 9	3 • 8						
Dielectric Withstanding Voltage				4 • 8	4 • 7						
Temperature rise	1										
Durability		3									
Vibration			2								
Shock (Mechanical)			3								
Thermal Shock				5							
Humidity				6							
Temperature life					5						
Salt Spray(Only For Gold Plating)						3					
Solder ability							1				
FPC Retention Force		2、4									
Terminal / Housing Retention Force								1			
Fitting Nail /Housing Retention Force								2			
Resistance to Soldering Heat									2		
Hand Soldering Temperature Resistance										2	
Sample Size	2	4	4	4	4	4	2	4	4	4	

